



# ENG-E18-084-1 - Distributors

JAE Electronics, Inc.  
April 10<sup>th</sup>, 2018

## PCN (Process Change Notice) MX19004P51\_MX19004P52 Additional Mold Die (H,J,K,L) To Keep Production Capacity

Part Number	2 Existing Mold Dies with 3 Cavities	1 Additional Mold Die with 4 Cavities	Additional Mold Die Completion	Proposed PPAP Submission	Start of Mass Production (SOP)
MX19004P51 MX19004P52	(E) (F,G)	(H,J,K,L)	Mid of July 2018	End of August 2018	First of September 2018  (after all PC PPAP approved from all Customers)

Notes:

- PC = Process Change (in Tooling: Transfer, Replacement, Refurbishment, or additional and Parts Produced at Additional Location, etc...)
- PPAP = Production Part Approval Process

1. PC PPAP will only be prepared and provided to customer who already requested and received Initial PPAP before.
2. If you need PC PPAP documents, please notify us ASAP.

For any question regarding this matter, please contact Nina Duong at [duongn@jae.com](mailto:duongn@jae.com)

**Thank you very much for your cooperation!**